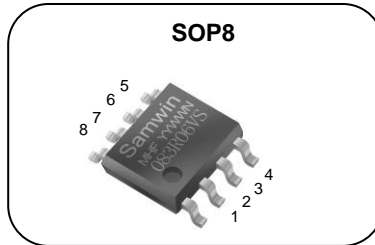


### N-channel Enhanced mode SOP8 MOSFET

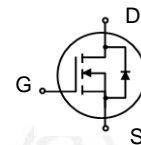
#### Features

- High ruggedness
- Low  $R_{DS(ON)}$  (Typ 12m $\Omega$ )@ $V_{GS}=4.5V$   
(Typ 9.5m $\Omega$ )@ $V_{GS}=10V$
- Low Gate Charge (Typ 18nC)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Application: Synchronous Rectification, Li Battery Protect Board, Inverter



4. Gate 5,6,7,8.Drain 1,2,3.Source

$BV_{DSS}$  : 60V  
 $I_D$  : 10A  
 $R_{DS(ON)}$  : 12m $\Omega$ @ $V_{GS}=4.5V$   
 9.5m $\Omega$ @ $V_{GS}=10V$



#### General Description

This power MOSFET is produced with advanced technology of SAMWIN. This technology enable the power MOSFET to have better characteristics, including fast switching time, low on resistance, low gate charge and especially excellent avalanche characteristics.

#### Order Codes

Item	Sales Type	Marking	Package	Packaging
1	SW K 083R06VSM	083R06VSM	SOP8	REEL

#### Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain to source voltage	60	V
$I_D$	Continuous drain current (@ $T_a=25^\circ C$ )	10*	A
	Continuous drain current (@ $T_a=70^\circ C$ )	9*	A
$I_{DM}$	Drain current pulsed (note 1)	40	A
$V_{GS}$	Gate to source voltage	$\pm 20$	V
$E_{AS}$	Single pulsed avalanche energy (note 2)	95	mJ
$E_{AR}$	Repetitive avalanche energy (note 1)	9	mJ
dv/dt	Peak diode recovery dv/dt (note 3)	5	V/ns
$P_D$	Total power dissipation (@ $T_a=25^\circ C$ )	2.4	W
	Derating factor above 25 $^\circ C$	0.02	W/ $^\circ C$
$T_{STG}, T_J$	Operating junction temperature & storage temperature	-55 ~ + 150	$^\circ C$

\*. Drain current is limited by junction temperature.

#### Thermal characteristics

Symbol	Parameter	Value	Unit
$R_{thja}$	Thermal resistance, Junction to ambient	52.4	$^\circ C/W$

Note:  $R_{thja}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{thjc}$  is guaranteed by design while  $R_{thca}$  is determined by the user's board design.



SOP-8  $R_{thja}$  : 52.4 $^\circ C/W$  on a 1 in $^2$  pad of 2oz copper.

## Electrical characteristic ( $T_J = 25^\circ\text{C}$ unless otherwise specified )

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
<b>Off characteristics</b>						
$BV_{DSS}$	Drain to source breakdown voltage	$V_{GS}=0V, I_D=250\mu A$	60			V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown voltage temperature coefficient	$I_D=250\mu A$ , referenced to $25^\circ\text{C}$		0.03		V/ $^\circ\text{C}$
$I_{DSS}$	Drain to source leakage current	$V_{DS}=60V, V_{GS}=0V$			1	$\mu A$
		$V_{DS}=48V, T_J=125^\circ\text{C}$			50	$\mu A$
$I_{GSS}$	Gate to source leakage current, forward	$V_{GS}=20V, V_{DS}=0V$			100	nA
	Gate to source leakage current, reverse	$V_{GS}=-20V, V_{DS}=0V$			-100	nA
<b>On characteristics</b>						
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1.4		2	V
$R_{DS(ON)}$	Drain to source on state resistance	$V_{GS}=4.5V, I_D=10A, T_J=25^\circ\text{C}$		12	14.5	m $\Omega$
		$V_{GS}=10V, I_D=10A, T_J=25^\circ\text{C}$		9.5	11.5	m $\Omega$
		$V_{GS}=10V, I_D=10A, T_J=125^\circ\text{C}$		14		m $\Omega$
$G_{fs}$	Forward transconductance	$V_{DS}=5V, I_D=10A$		32		S
<b>Dynamic characteristics</b>						
$C_{iss}$	Input capacitance	$V_{GS}=0V, V_{DS}=30V, f=1\text{MHz}$		1068		pF
$C_{oss}$	Output capacitance			354		
$C_{rss}$	Reverse transfer capacitance			13		
$t_{d(on)}$	Turn on delay time	$V_{DS}=30V, I_D=10A, R_G=4.7\Omega, V_{GS}=10V$ (note 4,5)		5		ns
$t_r$	Rising time			34		
$t_{d(off)}$	Turn off delay time			24		
$t_f$	Fall time			8		
$Q_g$	Total gate charge	$V_{DS}=48V, V_{GS}=10V, I_D=10A, I_G=3\text{mA}$ (note 4,5)		18		nC
$Q_{gs}$	Gate-source charge			2.2		
$Q_{gd}$	Gate-drain charge			4		
$R_g$	Gate resistance	$V_{DS}=0V$ , Scan F mode		1.8		$\Omega$

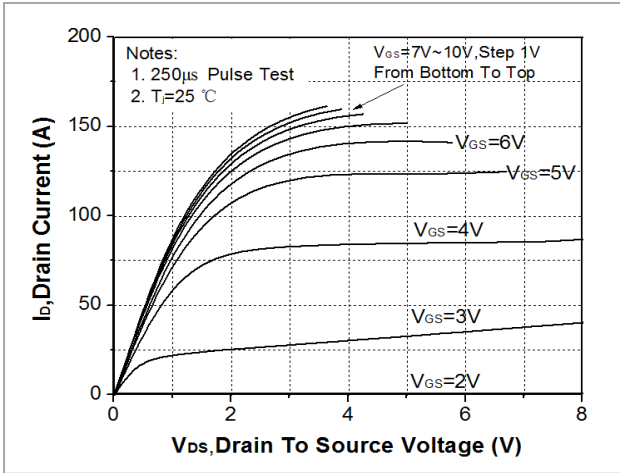
## Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			10	A
$I_{SM}$	Pulsed source current				40	A
$V_{SD}$	Diode forward voltage drop.	$I_S=10A, V_{GS}=0V$			1.4	V
$t_{rr}$	Reverse recovery time	$I_S=10A, V_{GS}=0V, di/dt=100A/\mu s$		29		ns
$Q_{rr}$	Reverse recovery charge			14		nC

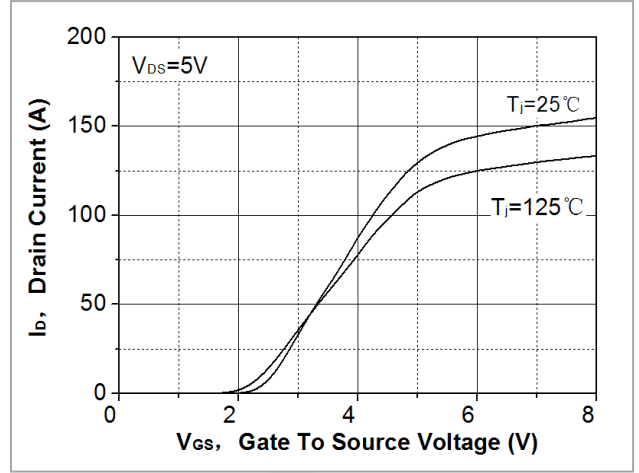
### ※. Notes

1. Repeattive rating : pulse width limited by junction temperature.
2.  $L=0.5\text{mH}, I_{AS}=19.5A, V_{DD}=40V, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$
3.  $I_{SD} \leq 10A, di/dt = 100A/\mu s, V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$
4. Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
5. Essentially independent of operating temperature.

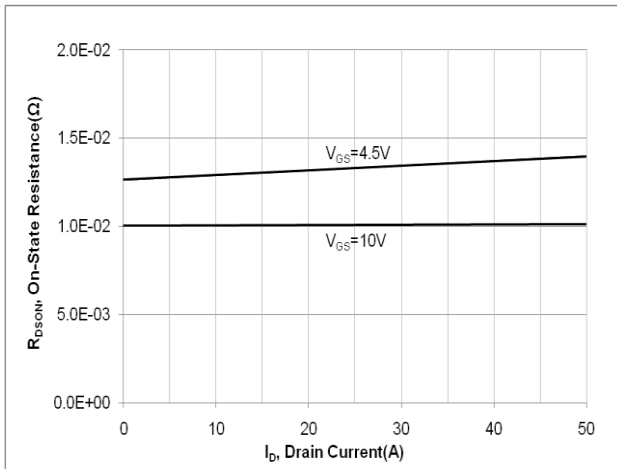
**Fig. 1. On-state characteristics**



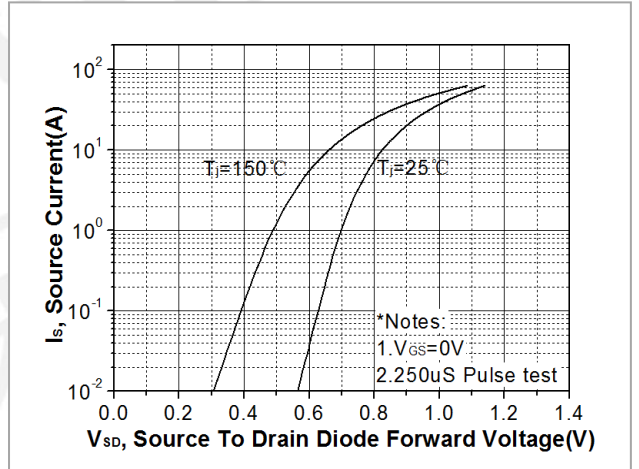
**Fig. 2. Transfer Characteristics**



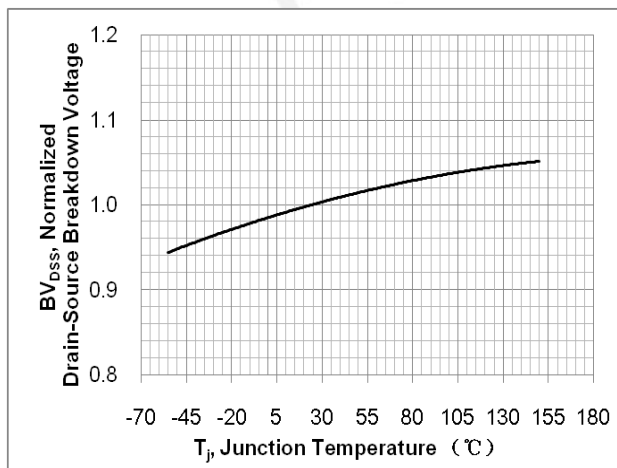
**Fig. 3. On-resistance variation vs. drain current and gate voltage**



**Fig. 4. On-state current vs. diode forward voltage**



**Fig 5. Breakdown voltage variation vs. junction temperature**



**Fig. 6. On-resistance variation vs. junction temperature**

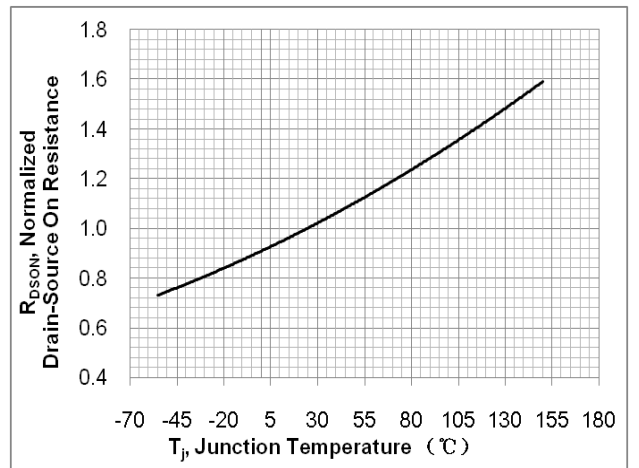


Fig. 7. Gate charge characteristics

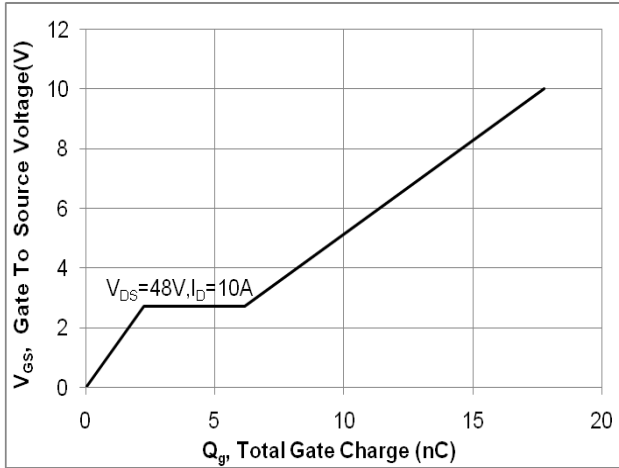


Fig. 8. Capacitance Characteristics

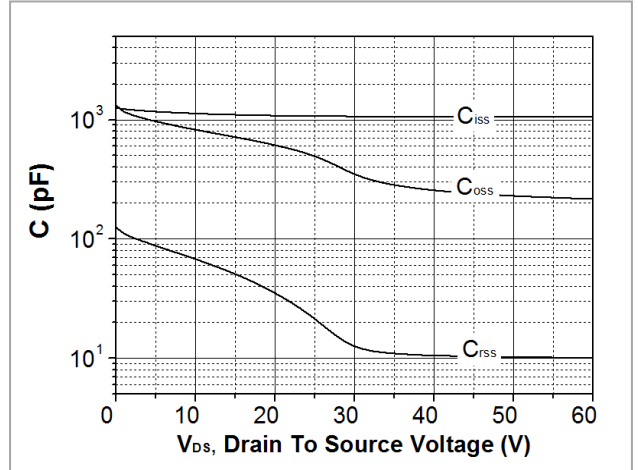


Fig. 9. Maximum safe operating area

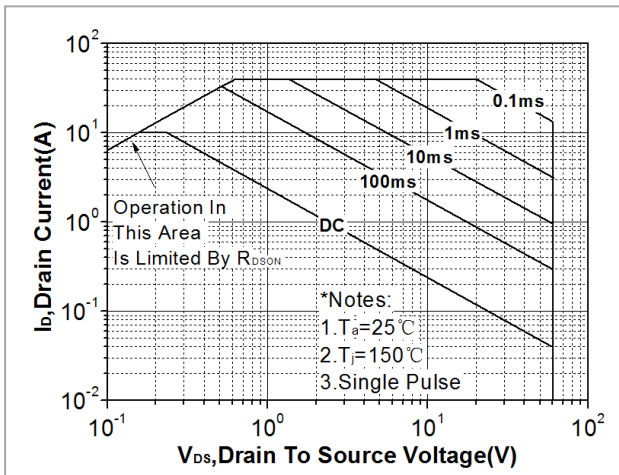


Fig. 10. Transient thermal response curve

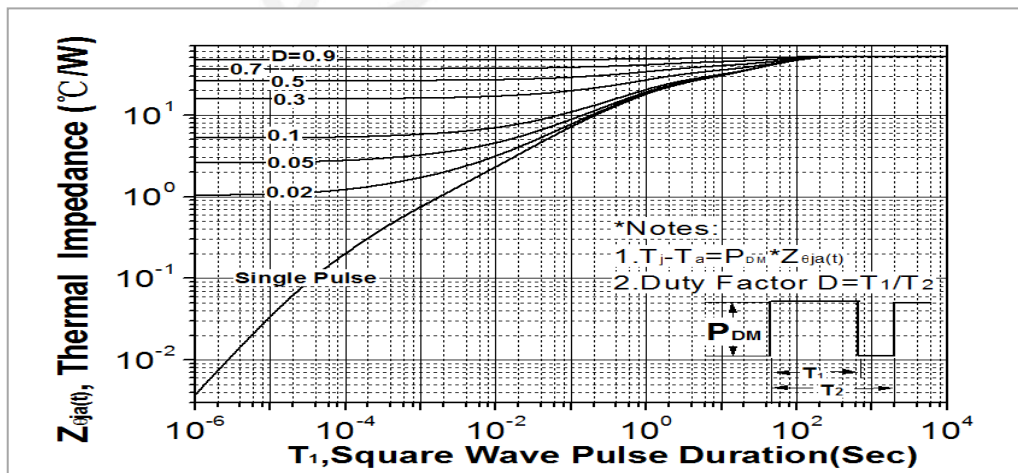


Fig. 11. Gate charge test circuit & waveform

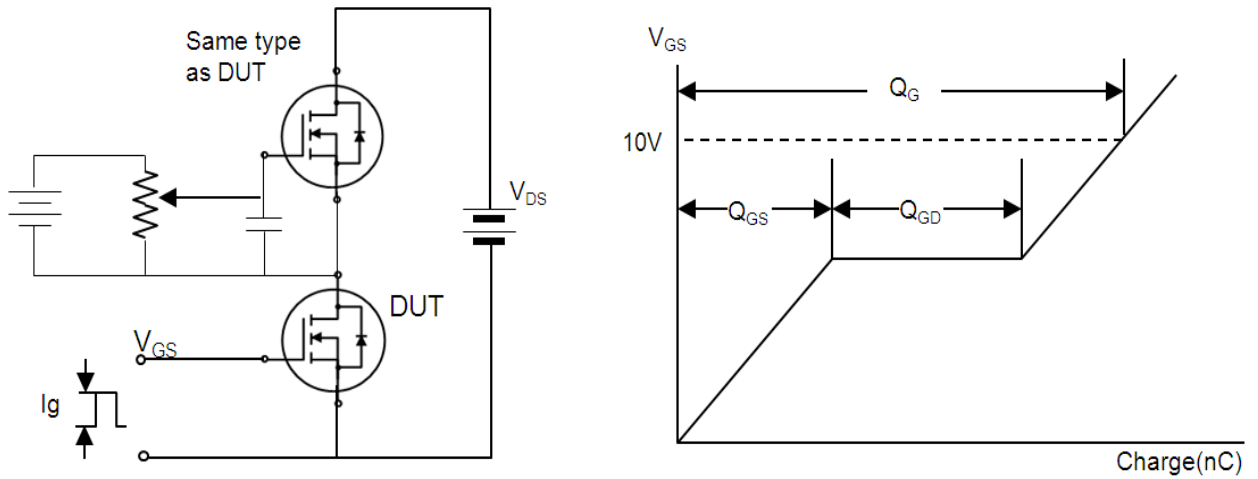


Fig. 12. Switching time test circuit & waveform

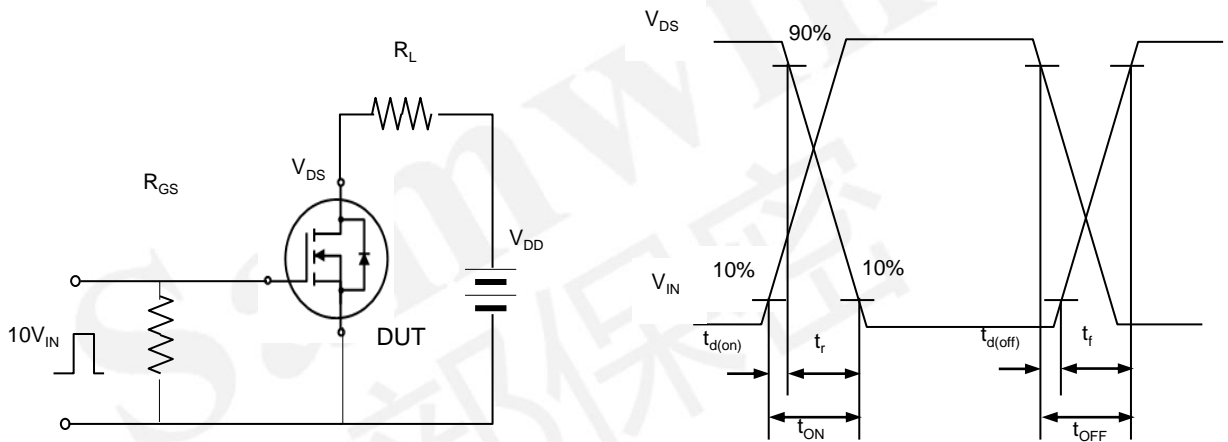


Fig. 13. Unclamped Inductive switching test circuit & waveform





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